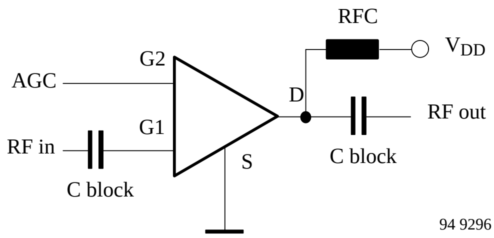
MOSMIC® for TV-Tuner Prestage with 12 V Supply Voltage

MOSMIC – MOS Monolithic **I**ntegrated **C**ircuit

Electrostatic sensitive device.
Observe precautions for handling.

Applications

Low noise gain controlled input stages in UHF- and VHF-tuner with 12 V supply voltage.



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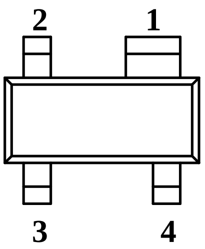
Features

- Integrated gate protection diodes
- Low noise figure
- High gain
- Biasing network on chip
- Improved cross modulation at gain reduction
- High AGC-range
- SMD package



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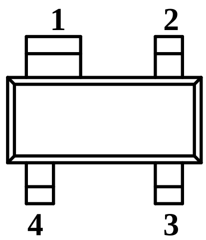

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S982T Marking: 982
Plastic case (SOT 143)
1 = Source; 2 = Drain; 3 = Gate 2; 4 = Gate 1

S982TR Marking: 82R
Plastic case (SOT 143R)
1 = Source; 2 = Drain; 3 = Gate 2; 4 = Gate 1

Absolute Maximum Ratings

Parameters		Symbol	Value	Unit
Drain source voltage		V_{DS}	16	V
Drain current		I_D	30	mA
Gate 1/gate 2-source peak current		$\pm I_{G1/G2SM}$	10	mA
Gate 1/gate 2-source voltage		$\pm V_{G1/G2SM}$	7.5	V
Total power dissipation	$T_{amb} \leq 60°C$	P_{tot}	200	mW
Channel temperature		T_{Ch}	150	°C
Storage temperature range		T_{stg}	–55 to +150	°C

Maximum Thermal Resistance

Parameters	Symbol	Maximum	Unit
Channel ambient on glass fibre printed board (25 x 20 x 1.5) mm^3 plated with 35 μm Cu	R_{thChA}	450	K/W

Electrical DC Characteristics

T_{amb} = 25°C

Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Gate 1-source breakdown voltage $\pm I_{G1S}$ = 10 mA, $V_{G2S} = V_{DS} = 0$	$\pm V_{(BR)G1SS}$	8		12	V
Gate 2-source breakdown voltage $\pm I_{G2S}$ = 10 mA, $V_{G1S} = V_{DS} = 0$	$\pm V_{(BR)G2SS}$	8		12	V
Gate 1-source leakage current $+V_{G1S}$ = 6 V, $V_{G2S} = V_{DS} = 0$	$+I_{G1SS}$			60	μA
Gate 1-source leakage current $-V_{G1S}$ = 6 V, $V_{G2S} = V_{DS} = 0$	$-I_{G1SS}$			120	μA
Gate 2-source leakage current $\pm V_{G2S}$ = 6 V, $V_{G1S} = V_{DS} = 0$	$\pm I_{G2SS}$			20	nA
Drain current V_{DS} = 12 V, V_{G1S} = 0, V_{G2S} = 6 V	I_{DSS}	50		500	μA
Self-biased operating current V_{DS} = 12 V, V_{G1S} = nc, V_{G2S} = 6 V	I_{DSP}	8	12	16	mA
Gate 2-source cut-off voltage V_{DS} = 12 V, V_{G1S} = nc, I_D = 200 μA	$V_{G2S(OFF)}$	1.0			V

Electrical AC Characteristics

V_{DS} = 12 V, V_{G2S} = 6 V, f = 1 MHz, T_{amb} = 25°C

Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Forward transadmittance	$\lvert y_{21s} \rvert$	25	30	35	mS
Gate 1 input capacitance	C_{issg1}		2.2	2.5	pF
Feedback capacitance	C_{rss}		20		fF
Output capacitance	C_{oss}		0.9		pF
Power gain g_S = 2 mS, g_L = 0.5 mS, f = 200 MHz g_S = 3.3 mS, g_L = 1 mS, f = 800 MHz	 G_{ps} G_{ps}	 17.5	 27 22		 dB dB
AGC range V_{DS} = 12 V, V_{G2S} = 1 to 6 V, f = 800 MHz	ΔG_{ps}	45			dB
Noise figure g_S = 2 mS, g_L = 0.5 mS, f = 200 MHz g_S = 3.3 mS, g_L = 1 mS, f = 800 MHz	 F F		 1 1.3		 dB dB

Caution for Gate 1 switch-off mode:

No external DC-voltage on Gate 1 in active mode!
Switch-off at Gate 1 with V_{G1S} < 0.7 V is feasible.
Using open collector switching transistor (inside of PLL), insert 10 kΩ collector resistor.

Common Source S-Parameters
V_{DS} = 12 V; V_{G2S} = 6 V

f/MHz	S_{11}		S_{21}		S_{12}		S_{22}	
	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG
	dB	deg	dB	deg	dB	deg	dB	deg
50	–0.02	–4.8	10.29	174.4	–61.79	87.6	–0.35	–1.9
100	–0.05	–9.3	10.20	168.1	–55.74	84.8	–0.38	–3.7
150	–0.14	–13.8	10.10	161.6	–52.32	81.5	–0.40	–5.5
200	–0.23	–18.2	9.97	155.4	–50.05	79.2	–0.43	–7.3
250	–0.35	–22.5	9.78	148.7	–48.45	76.3	–0.45	–9.1
300	–0.48	–26.6	9.64	143.2	–47.20	74.5	–0.47	–10.5
350	–0.63	–30.8	9.40	137.5	–46.23	72.5	–0.51	–12.2
400	–0.80	–34.7	9.24	132.0	–45.57	71.2	–0.55	–13.8
450	–0.95	–38.4	8.95	126.1	–45.19	69.4	–0.60	–15.3
500	–1.15	–42.2	8.74	121.1	–44.92	68.7	–0.63	–17.1
550	–1.31	–45.7	8.54	116.4	–44.76	69.0	–0.67	–18.4
600	–1.46	–49.3	8.31	111.2	–44.58	70.8	–0.69	–19.9
650	–1.62	–52.4	8.07	106.6	–44.57	72.3	–0.72	–21.6
700	–1.81	–56.0	7.85	101.9	–44.75	73.4	–0.75	–22.7
750	–1.95	–58.9	7.67	97.3	–45.03	76.3	–0.77	–24.6
800	–2.11	–62.0	7.47	92.7	–45.27	81.0	–0.79	–25.8
850	–2.26	–65.3	7.28	87.8	–45.52	86.6	–0.81	–27.5
900	–2.37	–68.2	7.08	83.3	–45.41	94.9	–0.83	–29.1
950	–2.49	–71.5	6.94	79.3	–44.79	103.7	–0.85	–31.0
1000	–2.62	–74.5	6.71	74.6	–44.21	107.4	–0.87	–32.3
1050	–2.76	–77.5	6.62	70.9	–43.95	113.3	–0.89	–33.9
1100	–2.90	–80.2	6.44	66.0	–43.64	120.8	–0.90	–35.3
1150	–2.98	–83.2	6.34	62.2	–42.73	128.9	–0.87	–37.2
1200	–3.07	–86.0	6.17	57.3	–41.82	135.7	–0.85	–38.8
1250	–3.14	–88.8	6.11	53.6	–40.68	142.1	–0.80	–40.4
1300	–3.24	–91.6	6.00	48.8	–39.80	146.1	–0.76	–42.4

Typical Characteristics (T$_j$ = 25°C unless otherwise specified)

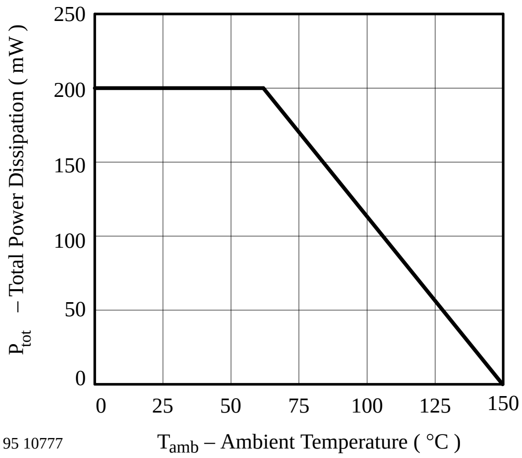


Figure 1. Total Power Dissipation vs. Ambient Temperature

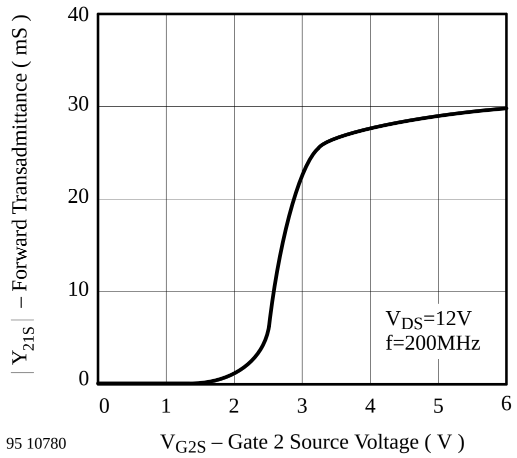


Figure 4. Forward Transadmittance vs. Gate 2 Source Voltage

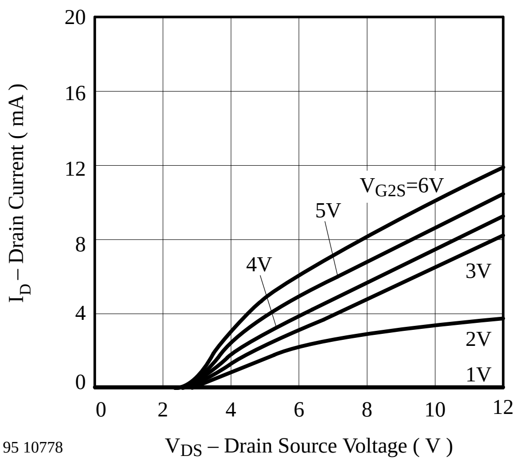


Figure 2. Drain Current vs. Drain Source Voltage

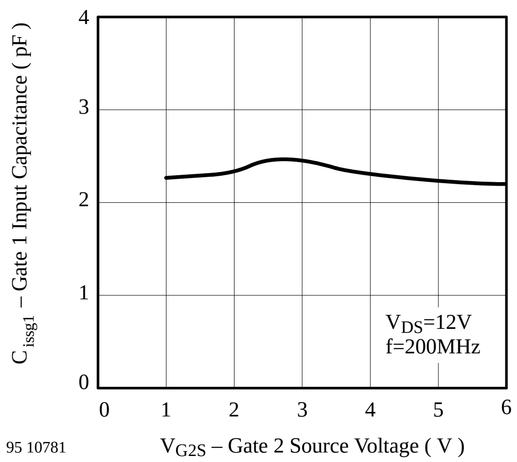


Figure 5. Gate 1 Input Capacitance vs. Gate 2 Source Voltage

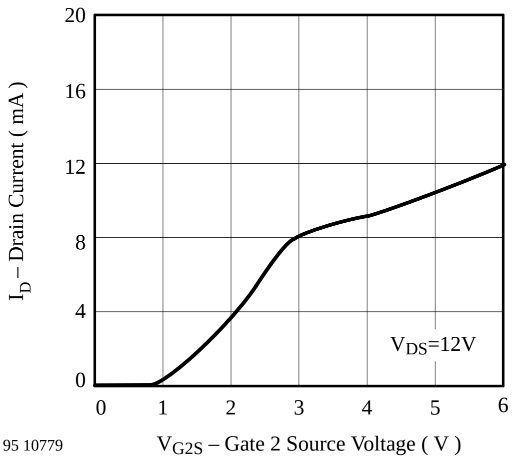


Figure 3. Drain Current vs. Gate 2 Source Voltage

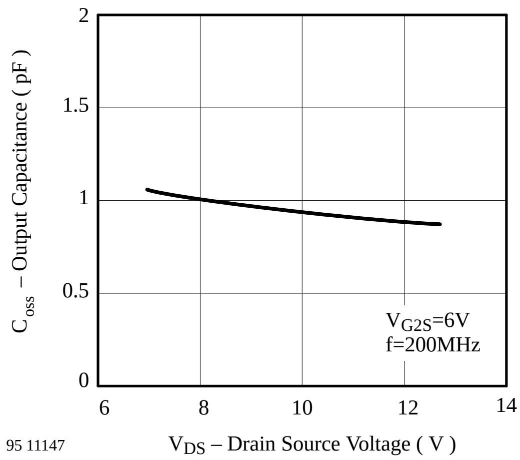


Figure 6. Output Capacitance vs. Drain Source Voltage

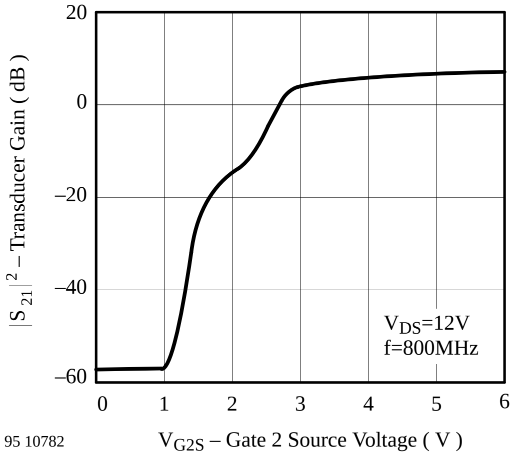


Figure 7. Transducer Gain vs. Gate 2 Source Voltage

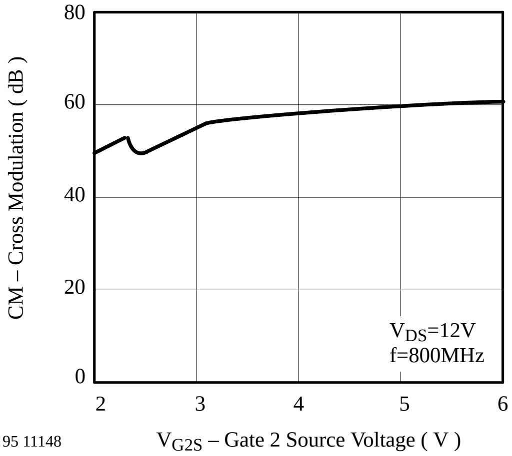
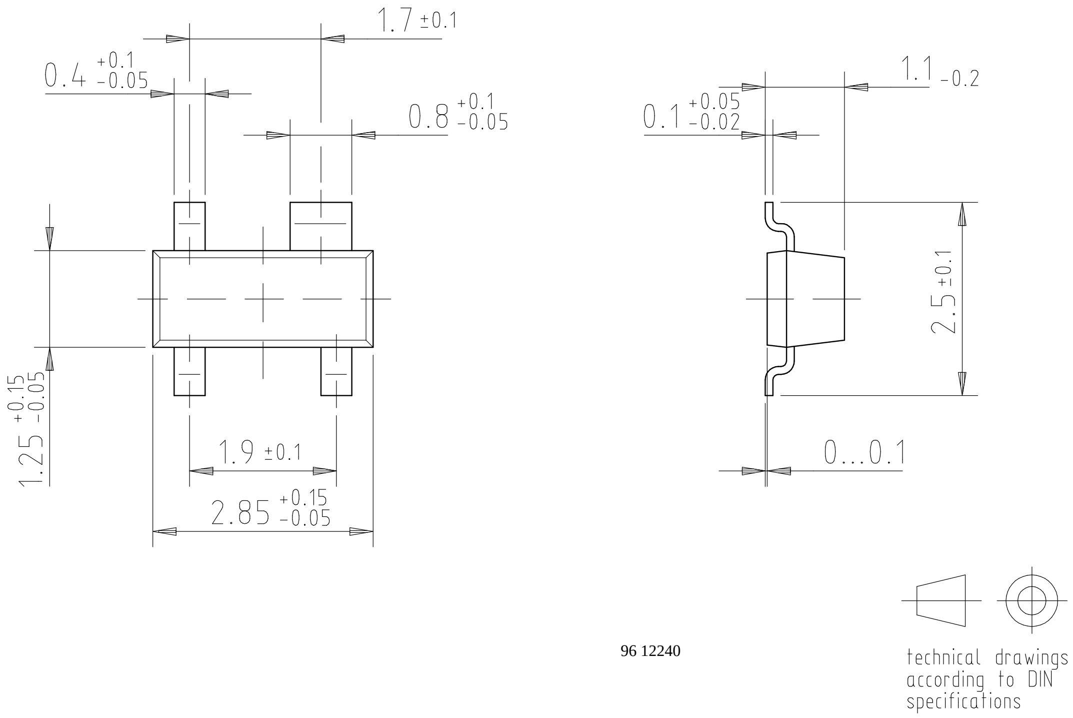
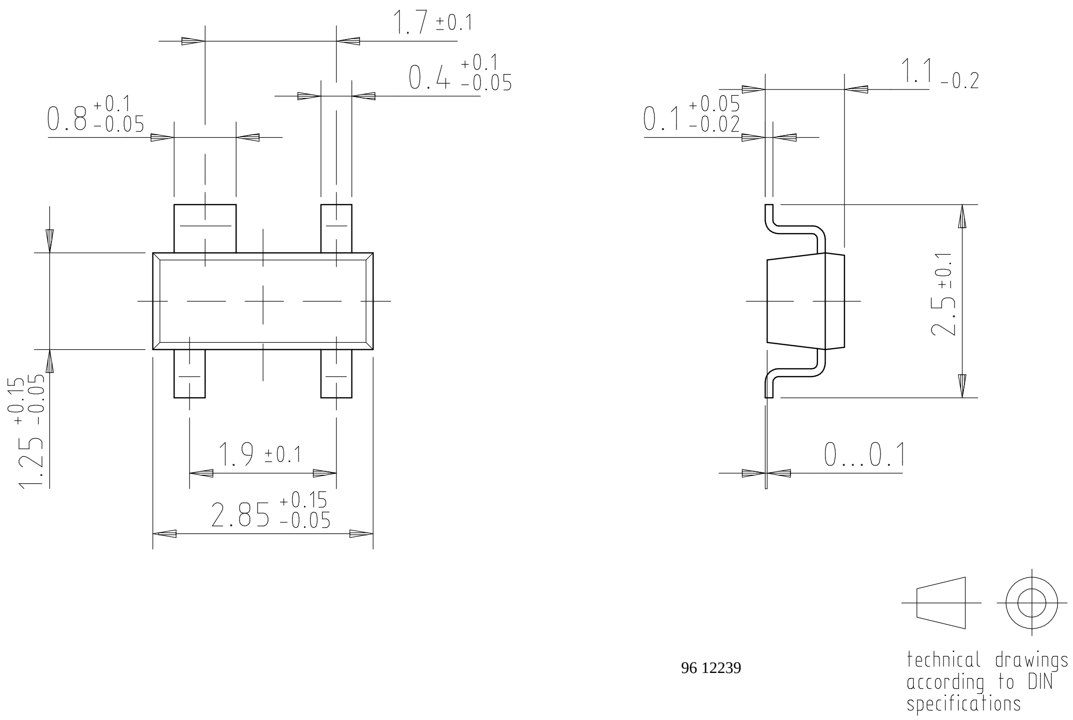


Figure 8. Cross Modulation vs. Gate 2 Source Voltage

Dimensions of S982T in mm



Dimensions of S982TR in mm



Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.

2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively

2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA

3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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